

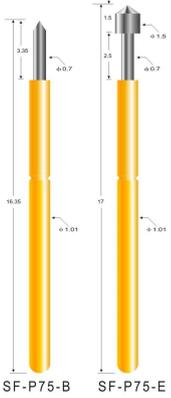
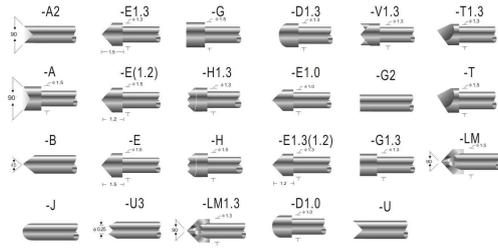
Sonde de contact à ressort pour test PCB

Information produit

Marque	SFENG
Numéro d'article	Sonde de contact à ressort pour test PCB
Séries	SF-PA75, SF-PA11 et SF-PA111
Piston	Be Cu, or / nickelé
Corps	Laiton, plaqué or
Printemps	acier inoxydable
Force de ressort	120g, 150g, et 120g
Current rapportn	3A



SF-P75



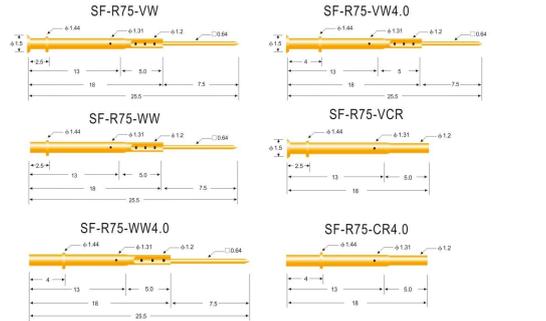
Probe specifications SF-P75(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Full travel(行程): 3.35(.1319")/2.50(.0984")
- Spring force(弹簧压力): 120g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated; SK4, Rh plated Barrel: Phosphor bronze, Gold plated Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50m Ω (毫欧姆)

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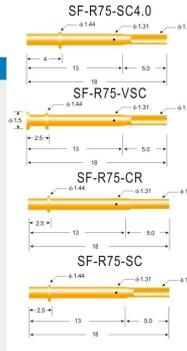
Noted: Specifications subject to change without notice(注: 规格变动不另行通知)

SF-R75



Probe specifications SF-R75(技术规格)

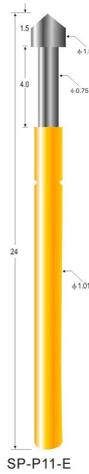
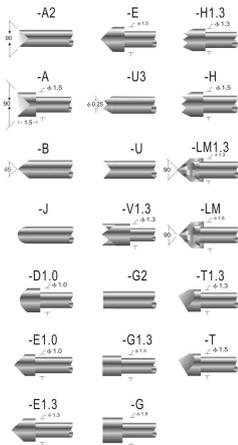
- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Materials and finishes(材料及涂饰): Barrel: Brass, Gold plated
- Connections(接线形式): Crimp: R75-VCR, R75-CR, R75-CR4.0 Solder cup: R75-VSC, R75-SC, R75-SC4.0 Wire wrap: R75-VW, R75-WW, R75-VW4.0, R75-WW4.0



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SF-P11



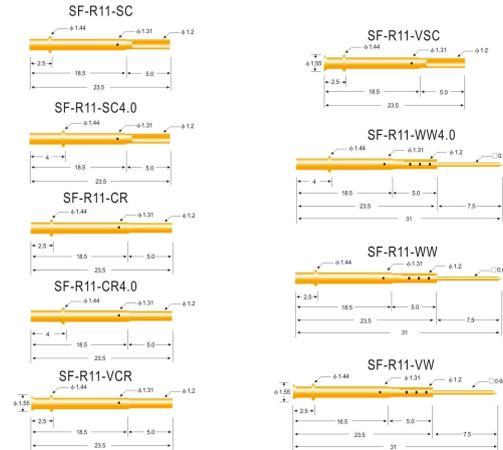
Probe specifications SF-P11(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Full travel(行程): 4.0(.1575")
- Spring force(弹簧压力): 150g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated Barrel: Brass, Gold plated Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50m Ω (毫欧姆)

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SF-R11



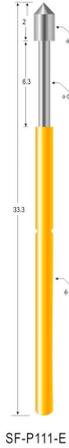
Probe specifications SF-R11(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Materials and finishes(材料及涂饰): Barrel: Brass, Gold plated
- Connections(接线形式): Crimp: R11-VCR, R11-CR, R11-CR4.0 Solder cup: R11-VSC, R11-SC, R11-SC4.0 Wire wrap: R11-VW, R11-WW, R11-WW4.0

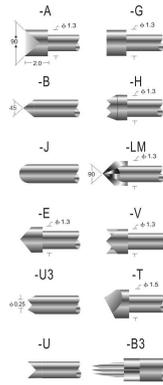
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SF-P111



SF-P111-E

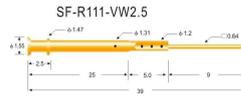
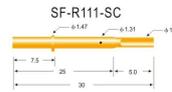
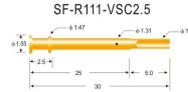
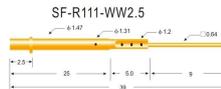
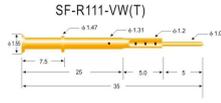
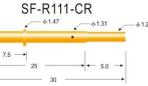
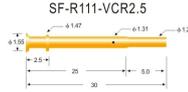


Probe specifications SF-P111(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压力: 1.35mm(.0532")
电木板、玻璃纤维板: 1.40mm(.0551")
- Full travel(行程): 6.3(.2481")
- Spring force(弹簧压力): 120g
- Materials and finishes(材料及涂饰):
Plunger: Be, Cu, Rh plated
Barrel: Brass, Gold plated
Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)

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SF-R111



Probe specifications SF-R111(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压力: 1.35mm(.0532")
电木板、玻璃纤维板: 1.40mm(.0551")
- Materials and finishes(材料及涂饰):
Barrel: Brass, Gold plated
- Connections(接线形式):
Crimp: R111-VCR2.5, R111-CR
Solder cup: R111-VSC2.5, R111-SC
Wire wrap: R111-VW2.5, R111-WW2.5, R111-WW
Terminal: R111-VW(T)

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Production Couler



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection

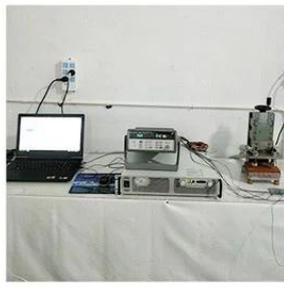


5. Finished products

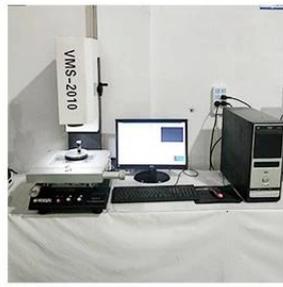


6. Packing

Tester Équipement



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope

Emballage et expédition

Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

